

# SPECIFICATION FOR APPROVAL

() Preliminary Specification

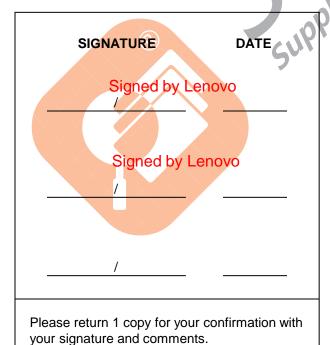
Version

( ) Final Specification

Title Customer	r Approval Sheet for Lenovo
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Customer	Lenovo
Part Number	SD19A6N5T8
SUPPLIER	BOE
MODEL	TV080WXM-NL0

Ex. 1.0





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# **RECORD OF REVISIONS**

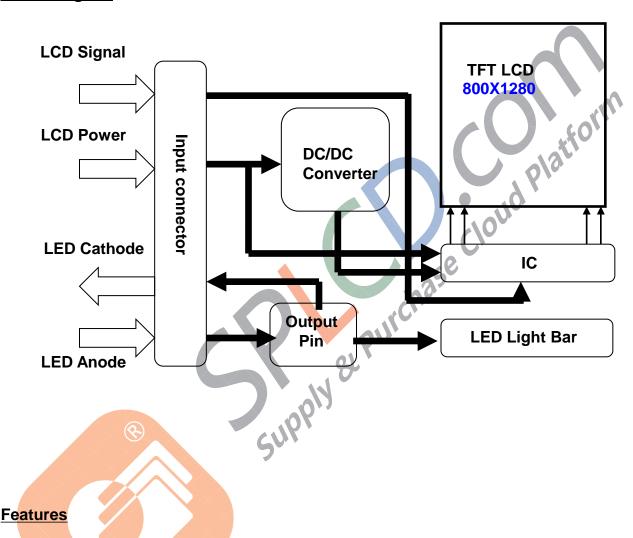
Revision No.	Revision Date	Page	Description
Ex.1.0	Ex.2015.03.27	-	First release
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#### 1-1. GENERAL DESCRIPTION

#### **Block Diagram**



TV080WXM-NL0 is 8" color TFT-LCD (Thin Film Transistor Liquid Crystal Display) module composed of LCD panel, MIPI driver IC, control circuit and backlight. By applying 8 bit digital data, 800×RGB (3) ×1280, 16.7M-color images are displayed on the 8" diagonal screen

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# 1-2. General Spec

No	Item	Specification	unit	Remark
1	Screen Size	8	inch	
2	Active Area	107.64(H) x 172.224(V)	mm	-
3	Panel Size	112.64(H)x181.24(V)	mm	-110
4	Outline Dimension	114.8(H) x 184.7(V)*2.55(typ)	mm	latif-
5	Display Resolution	800(H) ×RGB×1280 (V)	pixel	Plo -
6	Pixel Pitch	134.55(H)×134.55(V)	um	-
7	Display Method	a-Si		-
8	Display Mode	HADS	-	-
9	Display Color	16.7M	ı	8bit
10	Color Gamut	60	%	typ
11	Luminance	350(typ), 300(min)	nit	Typ, center P
12	Contrast Ratio	800:1 (typ) 600:1 (min)	-	Typ, center P
13	Viewing Angle	85/85/85	0	CR>10(U/D/L/R)
14	Pol Surface Treatment	AG25高精细	-	-
15	Weight	120	g	max
16	D-IC	NT35523B	-	Nova
17	Inversion Method	Z-Inversion		-
18	LED Q'ty	7S3P(21EA)	ea	String*Parallel
19	Power Consumption	White Patten: 1260 + 200=1460	mw	Backlight + Logic



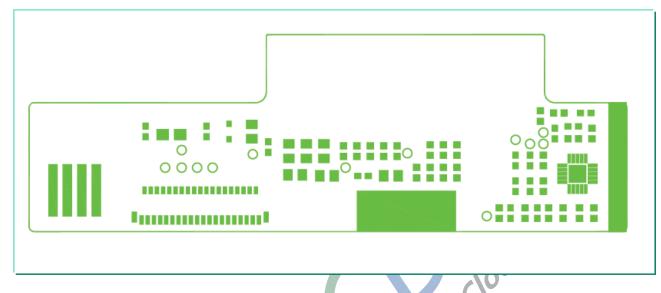
1-3. Key Part List(5pcs average data)

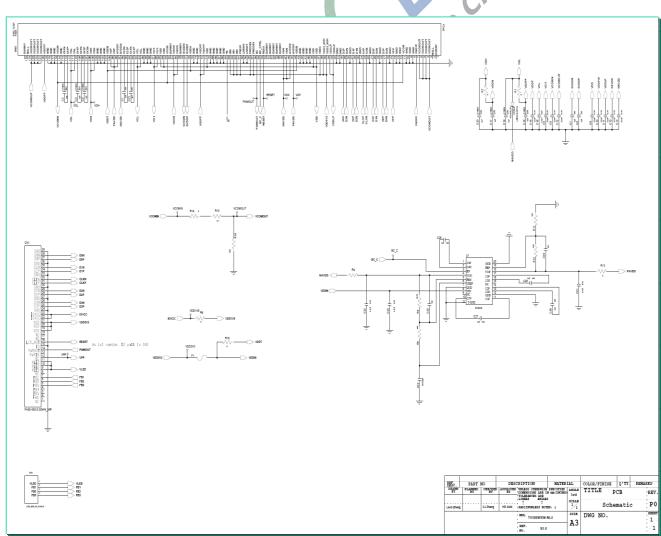
	item	Supplier	Spec/Size	Weight/ g	Remark
	TFT Glass	Corning	EXG/111.64*180.274*0.5 mm		
	C/F Glass	Corning	EXG/111.64*176.974*0.5 mm		
	Upper Pol	LGC	CF: 110.04*174.62 *0.119(mm)	2.87	
	Lower Pol	LGC	TFT: 112.04*177.87 *0.114(mm)	2.78	W/O APF
Cell	Liquid Crystal	Merck	ADS LC	0.06	
	UV Glue/Tuffy	-	-		
	D-IC	Novateck	NT35523B, 27.96*0.92*0.2mm	0.1	.40
	ACF(COG)	Sony	CP-36931	N/A	
	ACF(FOG)	Hitachi	AC-7813KM	N/A	
	COG Ass'y	-		12	
	EMI coating	-	-	10 N	
	Main Connector	Hirose	FH26W-39S-0.3SHW(05)	1	
	FPC	元盛	58*12.5*0.23mm	1	
	FPCA	元盛	58*12.5*0.23mm	5	
РСВА	Insulation Tape	-		ı	
	Conductive Tape	-	Oth,	ı	
	Release film on conductive tape		9	-	
	CNT Stiffener	-	-	-	
	B/W tape	SVS	SVS-DPTB-D-60#,T=0.06	N/A	
	Top Diffuser	SKC SKC	JS560HK,110um	3.68	
	Upper Prism	康得新	KBUO-100N, 89um	2.45	
	Lower Prism	康得新	KBCO-100S, 102um	2.87	
	Down Diffuser	东丽世韩	DL38N, 56um	1.2	
	LGP	艾宜格&嘉鸿	PC, 0.55mm	13.35	
BLU	Mold frame	通泰	PC	1	
	Double Tape	3M	-	0.1	
	Reflector	三菱	Lumirex100	1	
	Metal Frame	州巧	SUS304 0.15mm	27.34	
_	LED	隆达	Lexar,3806,0.6t	N/A	
	LED Lightbar	三迪	-	1	
	BLU Ass'y	CT	-		
Total	-	-	-	114	

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# 1-3-1. PCBA Gerber/Layout and Schematic Diagram



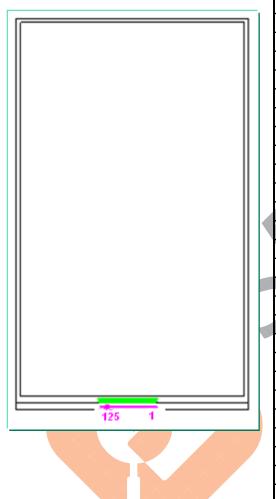


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# 1-3-2. FPC Pin Assignment

Please pay attention that IC bump down(TFT glass up and C/F glass down)

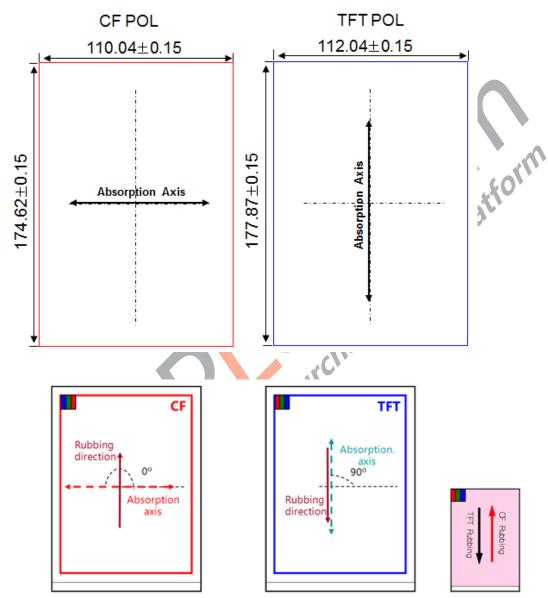


Julip do	ump down (TFT glass up and C/F glass down)								
1	DUMMY	43	VDDB	85	VCI1				
2	NULL	44	AVDDP	86	VCI1				
3	VCOMOUT	45	AVDDN	87	GND				
4	VCOMOUT	46	VSN	88	GND				
5	VCOMOUT	47	VSN	89	GND				
6	VCOMOUT	48	DUMMY	90	VCL				
7	VGOFF	49	DUMMY	91	VCL				
8	GND	50	DUMMY	92	C31P				
9	GND	51	DUMMY	93	C31N				
10	GND	52	DUMMY	94	C32P				
11	VCOM	53	RESX	95	C32N				
12	GND	54	BC_CTRL	96	AVDDN				
13	GND	55	ВС	97	AVDDN				
14	VPP	56	PMODE1	98	VSP				
15	GND	57	PMODE0	99	VSP				
16	D3N	58	LNSW1	100	VDDB				
17	D3P	59	LNSW0	101	GND				
18	GND	60	PNSW	102	GND				
19	D0N	61	IM2	103	GND				
20	D0P	62	IM1	104	VGH				
21	GND	63	IM0	105	VGH				
22	CKN	64	TE	106	C42N				
23	CKP	65	GND	107	C42P				
24	GND	66	GND	108	C41N				
25	D1N	67	GND	109	C41P				
26	D1P	68	GND	110	VGL				
27	GND	69	GND	111	VGL				
28	D2N	70	VDD	112	C51P				
29	D2P	71	VGOFF	113	C51N				
30	GND	72	VGOFF	114	GND				
31	GND	73	GND	115	VCOM				
32	VDDLP	74	GND	116	GND				
33	VDDLP	75	VDDA	117	GND				
34	VDD3_MIPI	76	GVDDP	118	GND				
35	VDD3_MIPI	77	GVDDN	119	VGOFF				
36	VDD3	78	DUMMY	120	VCOMOUT				
37	VDD	79	VGON	121	VCOMOUT				
38	VDD	80	VGON	122	VCOMOUT				
39	GND	81	DUMMY	123	VCOMOUT				
40	GND	82	VCOM	124	NULL				
41	GND	83	VDD	125	DUMMY				
42	GND	84	VDD						

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### 1-3-3. Pol General Spec



#### POL Spec:

Item CF POL		TFT POL	Remark
Material	Normal TAC	Normal TAC	
Surface	AG25	Clear	
Absorption Axis(°)	0	90	O-Mode
Transmittance(%)	42.2	42.2	
Thickness(um)	119	114	

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### 1-4. Change List

	No	No. Reason		<b>Change Details</b>		
	INO.	Reason	Before	After	Remarks	
	1.Change Prism Vendor	White Spot after Ball dropping	Prism (HS503+H50 3C)	Prism (KBUO-100N +KBCO-100S)		
H/W change						
	1.LGP size	Ball dropping NG	No fixed ears	Increase fixed ears		
Design Change	2.Change Cu tape size	Electrical conductivity NG	Litter contact area between Cu tape and B/C	Increase contact area between Cu tape and B/C		
S/W change						

### Remarks:

- 1.H/W change includes all materials, components, label etc.
- 2.Design change includes size, position etc.
- 3.S/W change includes initial code etc.

Please pay attention that this list is just a summary, an individual Design C hange List which contain much more information is also needed

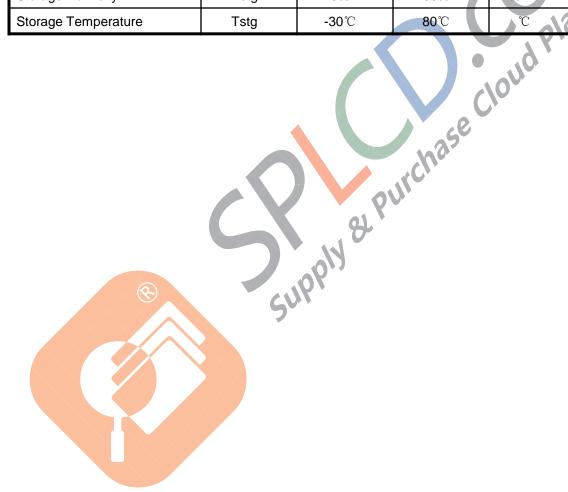


### 2-1. Absolute Maximum Ratings

The following are maximum values which, if exceeded, may cause faulty operation or damage to the unit.

**Table 2.1 Absolute Maximum Ratings** 

Doromotor	Symbol	Val	ues	Unito	Wates
Parameter	Symbol	Min	Max	Units	Notes
LCD Analog Voltage	VDD	-0.3	5	V	
LED Current	I <sub>LED</sub>	NA	30	mA	100
Storage Humidity	Hstg	5%	90%	%RH	.4O'
Storage Temperature	Tstg	-30℃	80℃	$^{\circ}$	



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#### 3-1. ELECTRICAL CHARACTERISTICS

**Table 3.1 Electrical Characteristics Of TFT-LCD Module** 

Parameter		Cumb of		Values		l lmit	Notes
		Symbol	Min	Тур	Max	Unit	Notes
LCD Input Analog	g Voltage	VCI	3.0	3.3	3.6	V	If necessary
LED Input Currer	nt	VDDI	1.7	1.8	1.9	V	
"H" Level Input V	'oltage	${ m I}_{ m LED}$	-	20	-	mA	
"L" Level Input V	oltage	$V_{IH}$	0.7xVDDI	-	VDDI	V	40,
"H" Level Output	Voltage	$ m V_{IL}$	0.0	-	0.3xVDDI	P	
"L" Level Output	Voltage	V <sub>OH</sub>	0.8xVDDI	-	VDDI	V	
Input high level le current	eakage	V <sub>OL</sub>	-	-	0.2xVDDI	V	
Input low level le current	akage	I <sub>IH</sub>			Ma 1	μА	
	Logic	I IL	-1	- 1	<u>-</u>	μА	
LCD Power	Sleep Mode	P <sub>N</sub>		0.2 (W pattern)	0.23(W pattern) 0.35(R/G/B pattern)	W	1
Consumption	BLU	$P_{N}$		1.26	1.386	W	

#### Notes:

(1) The specified current and power consumption are under the conditions at VDD =3.3V, T = 25°C, and fv = 60 Hz, at white pattern (TYP)

The specified current and power consumption are under the conditions at VDD = 3.3V, T = 25°C, and fv = 60 Hz, at R/G/B pattern (MAX)

(2) LED Backlight assumptions: 21 Vf(MAX), 60 mA. (7S3P LED Total Input )

### 3-2. Logic Power Consumption

Parameter	Symbol	Values		Units	Notes
i didilictei	Oymbor	Тур	Max	Offics	Notes
Normal Mode	$I_{VDD}$	60	70	mA	White Pattern
Sleep Mode	$I_{VDD}$	-	-	uA	White Pattern

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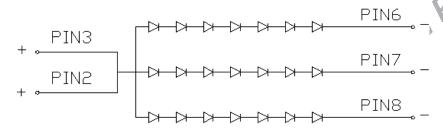


#### 3-3. BACK LIGHT UNIT

# 3-3-1 The edge-lighting type of back light unit consists of 21 LEDs which is connected in serial.

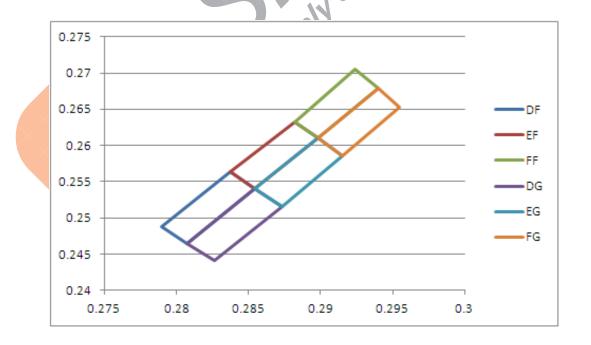
Table 2-3-1 Electrical Characteristics Of Back Light Unit

Parameter	Symbol		Values		Units	Notes
r ai ailletei	Symbol	Min	Тур.	Max	Ullits	
LED Current	I <sub>LED</sub>	-	20	-	mA	7S3P
LED Forward Voltage	$V_{LED}$		3.0	3.3	V	7\$3P



LED Circuit Diagram

#### 3-3-2 **LED Rank**



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#### 3-4. LCD INTERFACE CONNECTIONS

Interface Connector: FH26W-39S-0.3SHW(Hirose)

**Table 3.4 LCD Connector Pin Configuration** 

Pin No.	Symbol	I/O	Description		
1	NC	-	NC		
2	NC	-	NC		
3	NC	-	NC		
4	NC	-	NC		
5	FB3	Р	LED-		
6	FB2	Р	LED-		
7	FB1	Р	LED-		
8	NC	-	NC		
9	VLED	Р	LED+		
10	VLED	Р	LED+		
11	VLED	Р	LED+		
12	NC	-	7.5V For VPP		
13	LED PWMin	I	NC		
14	LED PWMout	0	LED PWMout		
15	ID	I/O	ID(GND for BOE)		
16	LCD_RST		Reset		
17	NC	-	NC		
18	NC		NC NC		
19	VDD	P	3.3V		
20	VDD	P	3.3V		
21	VDD	Р	3.3V		
22	IOVCC	P 0'	1.8V		
23	IOVCC	Р	1.8V		
24	GND	P	GND		
25	D3P	l	MIPI Input Data Pair D3P		
26	D3N	I	MIPI Input Data Pair D3N		
27	GND	P	GND		
28	D2P	I	MIPI Input Data Pair D2P		
29	D2N	I	MIPI Input Data Pair D2N		
30	GND	Р	GND		
31	CLKP	l	MIPI Input Data Pair CLKP		
32	CLKN	l	MIPI Input Data Pair CLKN		
33	GND	Р	GND		
34	D1P	I	MIPI Input Clock Pair D1P		
35	D1N	I	MIPI Input Clock Pair D1N		
36	GND	Р	GND		
37	D0P	I	MIPI Input Data Pair D0P		
38	D0N	Ī	MIPI Input Data Pair D0N		
39	GND	l	GND		

P:Power or GND, I:Input, O:Output

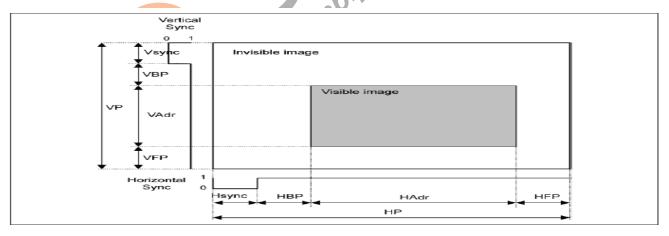
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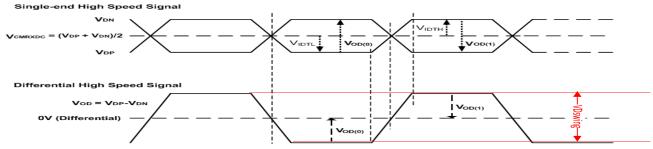


### 3-5. SIGNAL TIMING SPECIFICATIONS

ITEM		SYNBOL	min	typ	max	UNIT	
LCD		Frame Rate	-	-	60	-	Hz
		Pixels Rate	-	-	68.4	-	MHz
	DCLK	Frequency	fCLK	-	450	-	MHz
	DCLK	Period	Tclk	-	2.22		ns
		Horizontal total time	tHP	-	880	<b>-</b>	t <sub>CLK</sub>
		Horizontal Active time	tHadr		800		t <sub>CLK</sub>
	Horizontal	Horizontal Pulse Width	tHsync	-	16	-	t <sub>CLK</sub>
Timing		Horizontal Back Porch	tHBP	-	48	<b>]</b> (0)	t <sub>CLK</sub>
''''iig		Horizontal Front Porch	tHFP		16	13	t <sub>CLK</sub>
		Vertical total time	tvp	-	1296	-	t <sub>H</sub>
		Vertical Active time	tVadr		1280		t <sub>H</sub>
	Vertical	Vertical Pulse Width	tVsync	-	4	-	t <sub>H</sub>
		Vertical Back Porch	tVBP	-	4	-	t <sub>H</sub>
		Vertical Front Porch	tVFP	-	8	-	t <sub>H</sub>
Differential Swing			VDswing	-100	400	-	mV
	Bit Rate			"A-C"	450	-	Mbps
	Pixel Fomat			6 n.	24	-	Data bit/ pixel
		Lane	. 6	-	4	-	Lane

#### **%Please refer to initial code**





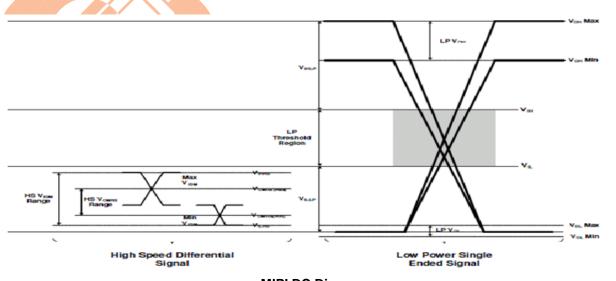
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# 3-6. MIPI Data&CLK Line Impedance Test Result

- (1) MIPI Interface Timing Sequence
- (a) MIPI interface DC characteristic:

Parameter	Symbol	Min	Тур	Max	Unit	Condition				
MIPI digital operation current	$I_{VCCIF}$	-	7	-	mA					
MIPI digital stand-by current	$I_{VCCIFST}$	ı	300	ı	uA					
	MIPI Characteristics for High Speed Receiver									
Single-ended input low voltage	$V_{ILHS}$	-40			mV	plati				
Single-ended input high voltage	${ m V_{IHHS}}$	ı		460	mV	9,				
Common-mode voltage	V <sub>CMRXDC</sub>	70	-	330	mV					
Differential input impedance	$Z_{\mathrm{ID}}$	80	100	125	Ω					
HS transmit differential voltage( $V_{OD}$ = $V_{DP}$ - $V_{DN}$ )	V <sub>OD</sub>	140	200	250	mV					
	MIPI Chara	cteristics f	or Low Po	wer Recei	ver					
Pad signal voltage range	VI	0	0-	1350	mV					
Ground shift	$V_{GNDSH}$	-50	_	50	mV					
Output low level	V <sub>OL</sub>	-50	-	50	mV					
Output high level	V <sub>OH</sub>	1.1	-	1.3	V					



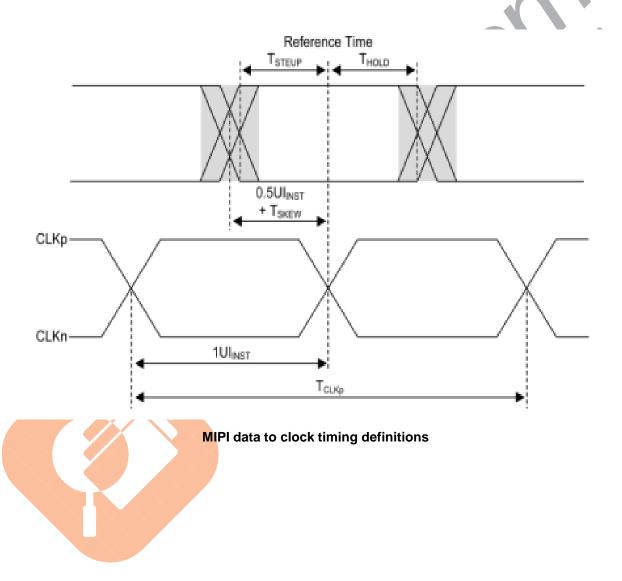
**MIPI DC Diagram** 

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### (b) MIPI data to clock timing definitions

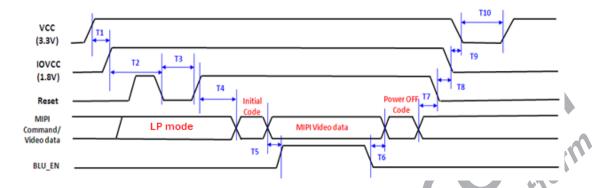
Clock Parameter	Symbol	Min	Тур.	Max.	Unit
UI instantaneous	UI INST	2	_	4	ns
Data to Clock Setup Time [Receiver]	T SETUP[RX]	0.15		_	UI INST
Clock to Data Hold Time [Receiver]	T HOLD[RX]	0.15	_	-	UI INST



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# 3-7. Power On/Off Sequence



	POWER ON	/OFF Timing	
noromotoro	Va	Unit	
paremeters	Min.	Max.	Omt
T1	0.5	10	
T2	15	100	410
T3	0.02	0.5	
T4	20	200	
T5	200	500	
T6	40	200	ms
T7	100	200	
T8	1	100	
Т9	No Limit	No Limit	
T10	500	No Limit	
<b>®</b>	Supply	A.	





### 3-8. IC General Spec and Size

# **General Description**

The NT35523B device is a single-chip solution for a-Si TFT LCDthat incorporates gate drivers and is capable of

800RGBx1280, 768RGBx1280, 720RGBx1280, 640RGBx1024, 600RGBx1024 and 540RGB x 960without

internal CGRAM.It includes a timing controller with glass interface level-shifters and a glass power supply circuit.

The NT35523Bsupports MIPI Interfaceonly.

The NT35523B is also able to make gamma correction settings separately for RGB dots to allow benign

adjustments to panel characteristics, resulting in higher display qualities.

This LSI is suitable for small or medium-sized portable mobile solutions requiring long-term driving capabilities,

including bi-directional pagers, digital audio players, cellular phones and handheld PDA.

#### **FEATURES**

VGHO/VGLOvoltage generatorfor gate control signal and panel

Oscillator for display clock

Supports gate control signals to gate driver in the panel

Content Adaptive Brightness Control (CABC)

Image Enhancement (IE): include brightness/edge/vividcolor enhancement

Sunlight Readability Enhancement(SRE)



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# 3-9. Power Consumption

	Parameter	Symbol	Тур	Unit	Remarks		
		L0	153	mW			
		L32	165	mW			
		L64	165	mW			
		L96	168.3	mW			
		L127	168.3	mW			
		L160	168.3	mW			
		L192	168.3	mW			
	Logic Power	L224	171.6	mW			
	Logic Fower	L255	171.6	mW			
CABC off		R255	297	mW			
CABC OII		G255	297	mW			
		B255	297	mW	0/0		
		8 color bar	280.5	mW			
		0-255 Gray Transition	280.5	mW			
		Lenovo UI	-	mW	Lenovo will send pic.		
		Icon Interface	- mW		Lenovo wiii sena pic.		
		25% on	0.315	W			
	BLU	50% on	0.63	W			
	BLO	7 <mark>5%</mark> on	0.945	W			
		100 <mark>% o</mark> n	1.26	W			
BLU 75% on 0.945 W 100% on 1.26 W							



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#### 4. OPTICAL CHARACTERISTICS

# 4-1. Optical Characteristics – Backlight 100%

Parameter	Symbol	Condition	Min	Тур	Max	Unit	Remarks
	Θ12		80	85	-	0	Note 1
	Θ6	OD : 40	80	85	1	۰	Note 1
	Θ9	CR >10	80	85	-	٥	Note 1
M's de Assila	Θ3		80	85	-	°	Note 1
Viewing Angle	Θ1		80	85	-	0	Note 1
	Θ4	OD: 40	80	85	-	٥	Note 1
	Θ7	CR>10	80	85	-	•	Note 1
	Θ11		80	85	-	°	Note 1
Contrast Ratio	CR	Optimal	600	800	-	-71	Note 1,4
Brightness	Lv	Optimal	300	350		cd/m²	Note 1
Brightness Uniformity	Υ	Optimal	80	85	-	10%	Note 1,7(9P)
Flicker				-30		dB	Note 1,2
Crosstalk					20	%	Note 1,3
Response time	T <sub>f</sub> Or T <sub>r</sub>	Θ =0 ° Ta =25 °C	-	25	35	ms	Note 1,6
Color Gamut	NTSC	-	55	60	-	%	Note 1
White Chromoticity	Х	CIE 1931	0.27	0.30	0.33	-	Note 1
White Chromaticity	У	CIE 1931	0.29	0.32	0.35	-	Note 1
Dad Chromoticity	Х	CIE 1931	0.586	0.616	0.646	-	Note 1
Red Chromaticity	у	CIE 1931	0.326	0.356	0.386	-	Note 1
Croop Chromoticity	X	CIE 1021	0.301	0.331	0.361	-	Note 1
Green Chromaticity	у	CIE 1931	0.569	0.599	0.629	-	Note 1
Plus Chromoticity	Х	CIE 1931	0.125	0.155	0.185	-	Note 1
Blue Chromaticity	у	CIE 1931	0.058	0.088	0.118	-	Note 1

4-2. Cell&BLU Optical Characteristics

Parameter	Тур	Unit	Remarks
Aperture Ratio	64%	%	
Upper Pol Trans.	42.5	%	
Lower Pol Trans.	41.4	%	
Panel Trans.	4.6%	%	w/o APF
Panel Trans.	-	%	with APF
BLU Luminance	7600	Cd/m <sup>2</sup>	Center
BLU Luminance Uniformity	85%typ;80%min	%	9PIONT

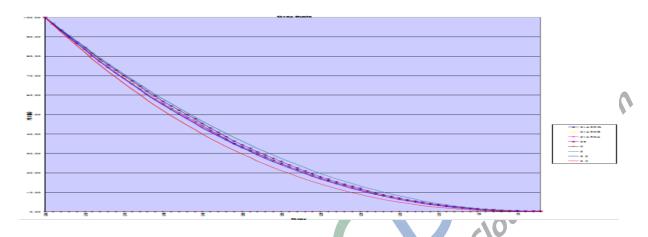
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# 4-3. Gamma/Color Coordinate Uniformity/CE Function/CABC Function (TBD)

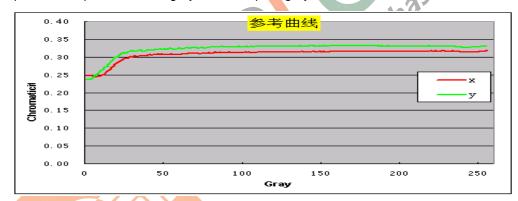
#### 4.3-1 Gamma Curve

Request: R/G/B/W, 0-255 gray scale, step 1 gray scale



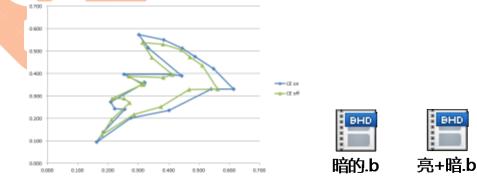
#### 4.3-2 Color Coordinate Uniformity

Request: white pattern, 0-255 gray scale, step 15 gray scale.



4.3-3 CE function(on and off)

Request: Macbeth color checker. Please provide all CE on data if there is more than one CE solution. Need color coordinate of Macbeth color checker, while CE on and CE off



4.3-4 CABC function(on and off)

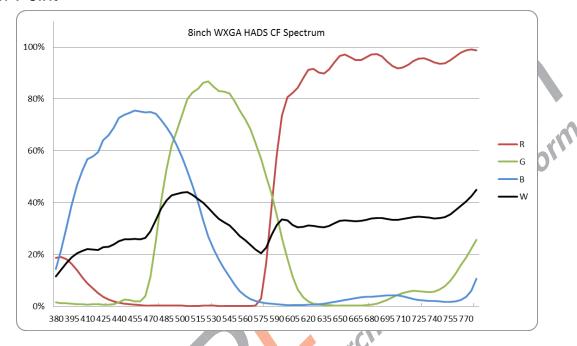
Request: Movies comparison( three segments with different frames details, lighter, light+dark, darker) Measure LCD power consumption of three segments, including logic and BLU

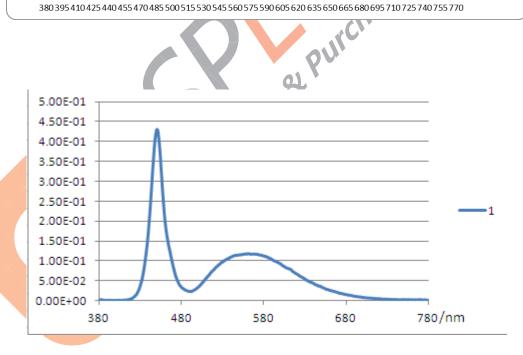
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# 4-4. LCD Spectrum and BLU Spectrum

#### **Center Point**





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#### [Note 1] Optical Test Equipment Setup

The LCD module should be turn-on to a stable luminance level to be reached. The measure ment should be executed after lighting Backlight for 20 minutes and in a dark room.

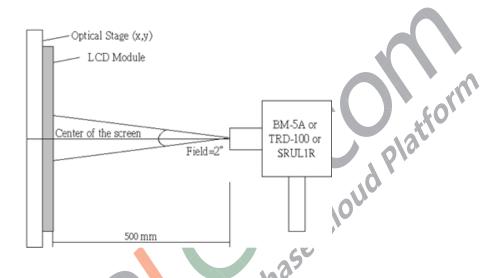
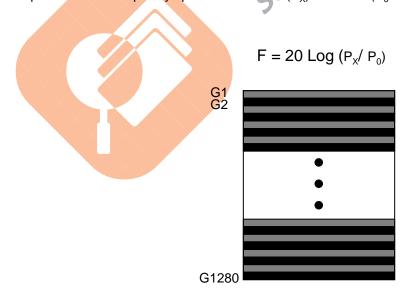


Fig 4.1. Optical Characteristic Measurement Equipment and Method

#### [Note 2] Flicker

The flicker level should be measured with horizontal gray/black stripes. The flicker is essentially a ratio of the powers in the frequency spectrum at 30 Hz ( $P_X$ ) and 0 Hz ( $P_0$ . DC level).



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[Note 3] Crosstalk

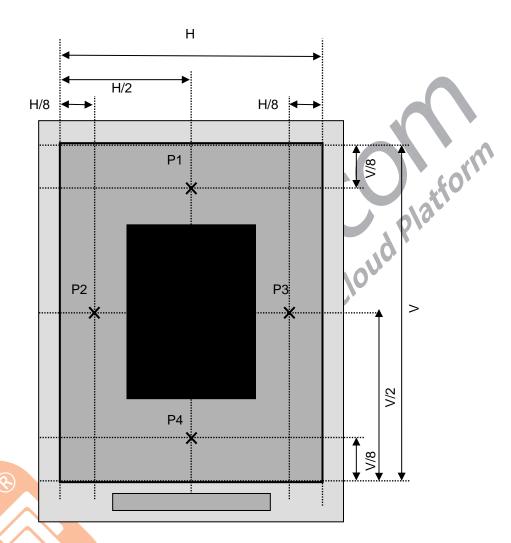


Fig 2-5. Crosstalk measurement points

A: Luminance for P1 ~ P4 with all 127 gray pixels

B: Luminance for P1 ~ P4 with 127 gray pixels when the black box is applied

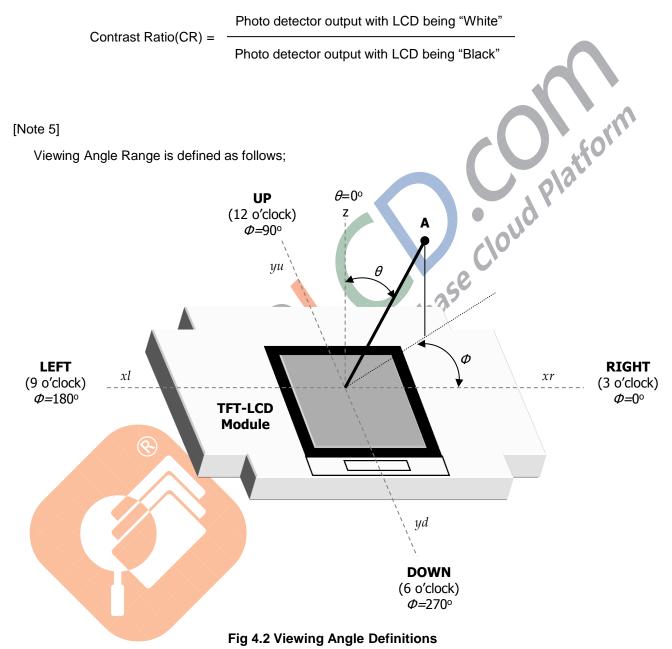
Crosstalk [%] = Maximum 
$$\left[ Absolute \left( \frac{A - B}{A} \right) \right]$$

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#### [Note 4]

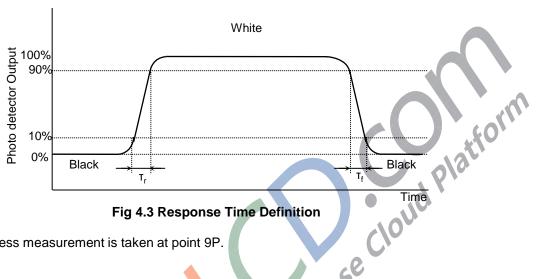
Contrast Ratio is defined as follows;





#### [Note 6]

Response time is obtained by measuring the transition time of photo detector output, when input signals are applied so as to make the area "black" to and from "white".



[Note 7]

Fig 4.3 Response Time Definition

The brightness measurement is taken at point 9P.

Minimum Photo detector output for P1-P9 with all pixels white **Brightness** X 100 Maximum Photo detector output for P1-P9 with all pixels white Uniformity W/3

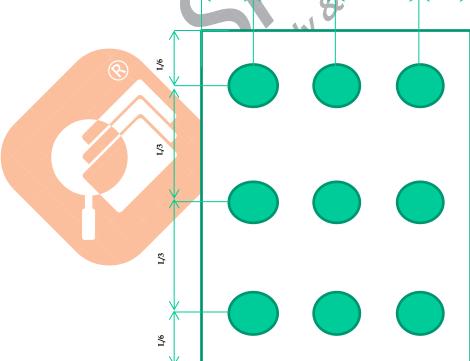


Fig 4.4 Brightness Measurement Points

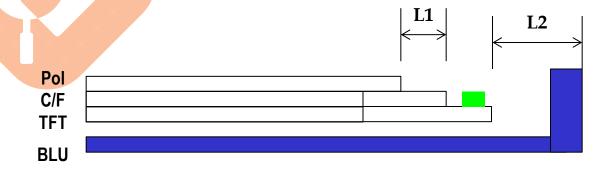
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### 5. MECHANICAL CHRACTERISTICS

The contents provide general mechanical characteristics for the model. In addition the figures in the next page are detailed mechanical drawing of the LCD.

Items	Description	Тур.	Tolerance	Unit
Mother Glass	Size	2500*2200	-	mm
Q-Panel	Size	710.64×371.648 mm	-	mm
C/F and TFT thickness after slimming	thickness	0.5/ 0.5	±0.02	mm
	A/A	107.64*172.224	-	mm
	C/F	111.64*176.974	±0.2	mm
	TFT	111.64*180.274	±0.2	mm
Panel	BM(U/D/L/R)	2.4/4.05 /2.5/2.5	Clo	mm
	IC Bonding Area	3.3	<del>-</del>	mm
	Pol Size	CF: 110.04*174.62	-	mm
	Gap Between Pol~C/F border (U/D/L/R)	CF: 1.2/2.854/1.3/1.3	±0.3	mm
	Horizontal	114.8	±0.3	mm
	Vertical	184.7	±0.3	mm
Module	Thickness	2.55	±0.15	mm
	UV Glue Thickness	<0.10	-	mm
	Gap between Glass~L CM outline	1.18/1.08/1.08/1.696	±0.3	mm



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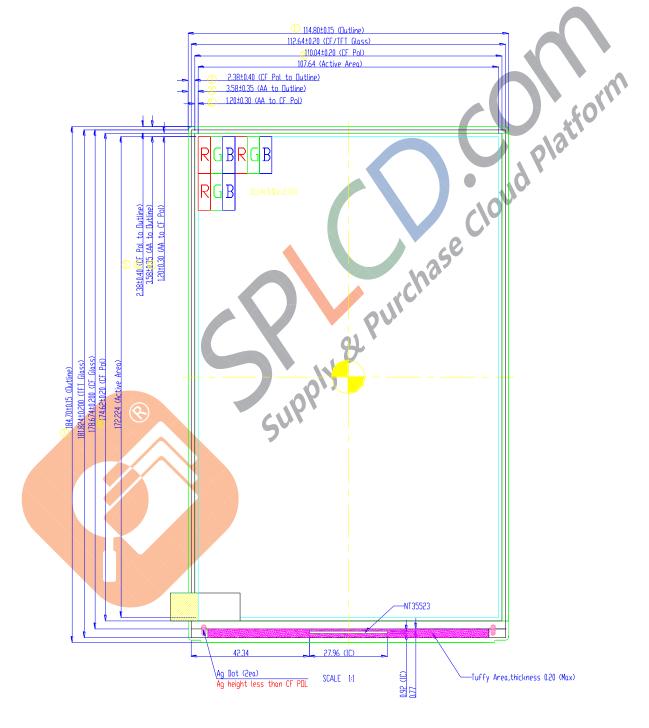


### 5.1 LCM Drawing

#### Folded and unfolded status

(1) Front side

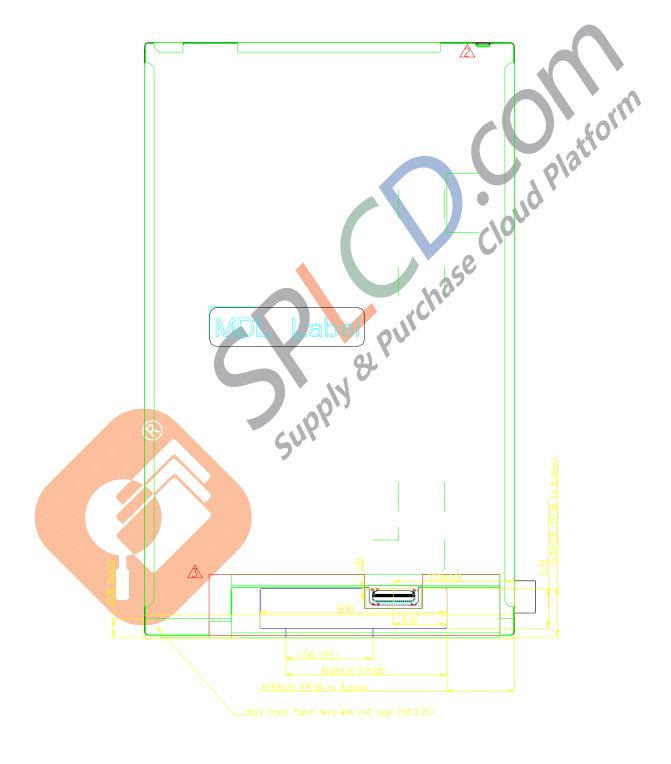
The tolerance, not show in the figure, is  $\pm 0.2$ mm. [Unit : mm]





(1) Rear side

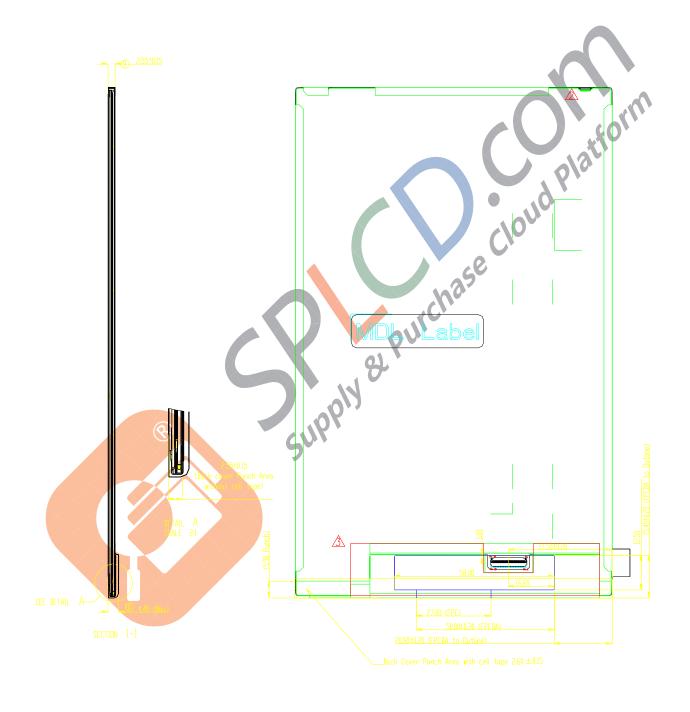
The tolerance, not show in the figure, is  $\pm 0.2$ mm. [Unit : mm]



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# 5.2-1 BLU Outline Dimension Including each film

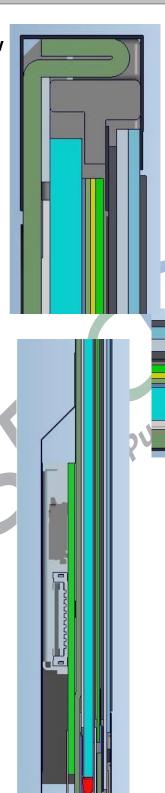


J.d. Platform



# **Product Specification**

### 5.2-2 BLU Section Review

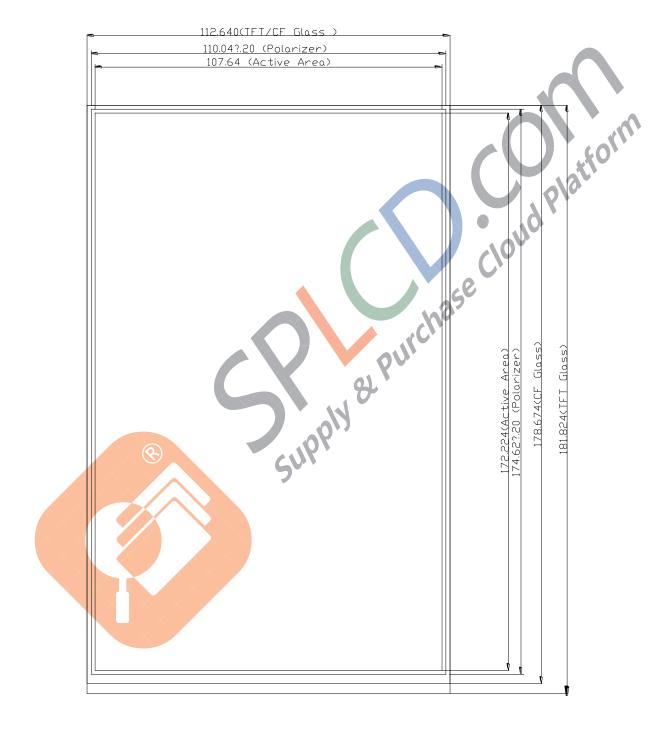


For Example

Remarks: Need L/R/U/D c enter point section stack-up, if there is difference in corne r design, please add corner s ection review

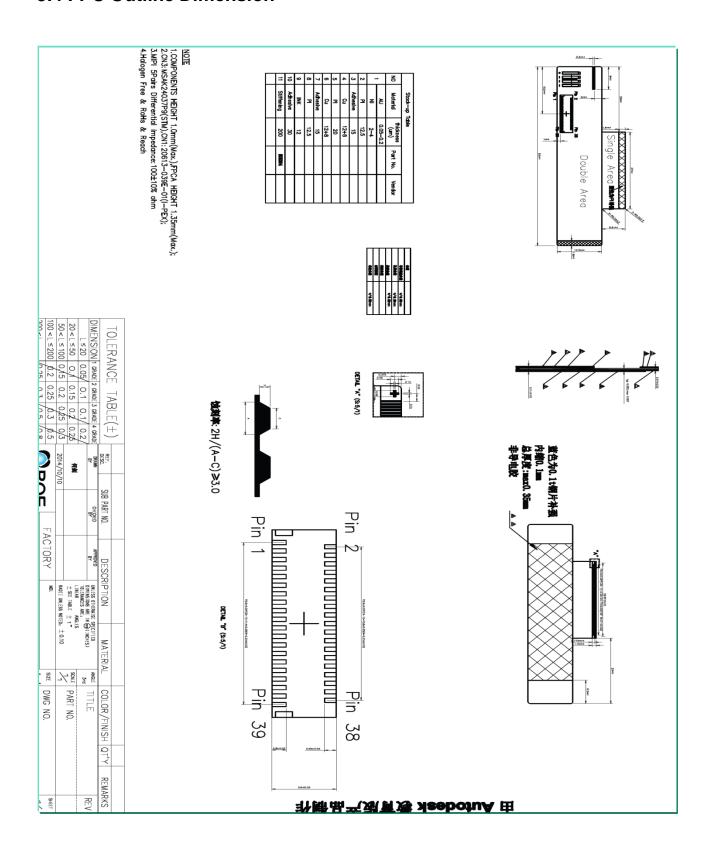


### **5.3 Panel Outline Dimension**





#### **5.4 FPC Outline Dimension**





#### 6. RELIABLITY TEST

Must be accordance with Lenovo RA test items

Test Items	Conditions
Operation Temperature	-20°C To 60°C
Operating Humidity	5% ~ 90%
Temperature when stored	-30°C To 80°C
Humidity when stored	5% ~ 90%
MTBF	>10,000POH

If after 10,000 hours, the brightness of the panel is 50% greater than the initial value, the MTBF report and SDA test report should be given to providers.



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# 7. Safety & Environment Test Reports

GP资料已上上传联想系统

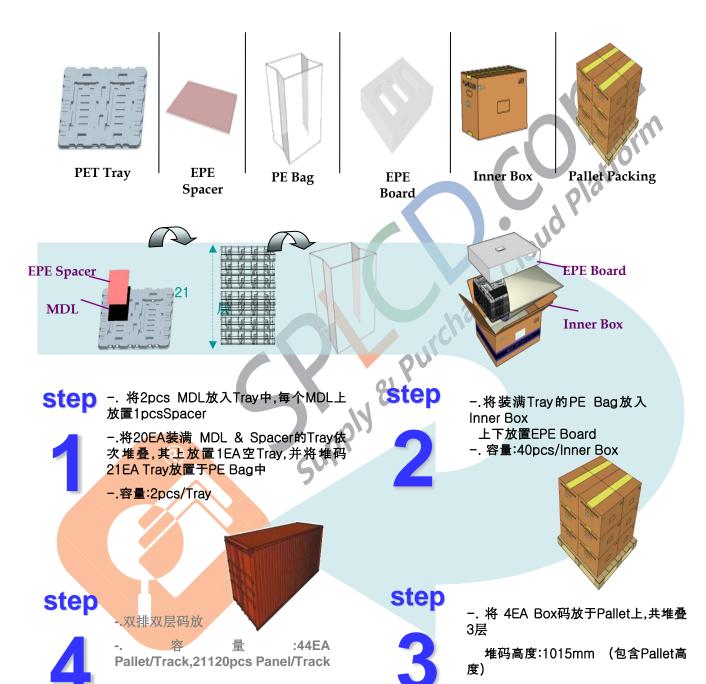
1			
2	lenovo联想 Req	uired data for Environmental Compliance	Template/Sample
3	GDX Data(Mandatory)	Lenovo Supplier Material Self-Declaration_Commodities	Lenovo Supplier Materiai Self- Declara
4		FMD data	FMD_Import_Sampl
5	RoHS Test reports(Mandatory)	Lenovo MIDH RoHS Test Reports and MSDS Summary	Leneve MBC ReHS Text Reports and
6	MSDS(Conditional)	Lenovo MIDH RoHS Test Reports and MSDS Summary	Lonevo MBC ReHS Test Reports and
8	Remarks:		
	1. FMD exemptions can be only app 2. REACH test reports are needed	under below conditions:	roqui rozont
9	a. New suppliers & nazardous sub b. Hazardous substances is detec	stances control is not well performed to meet Lenovo's r ted or suspected by Lenovo.	շզաութացու.
10			

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### 8. Package

# 8.1. Packing Description



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定,缠绕膜包裹

MDL/Pallet

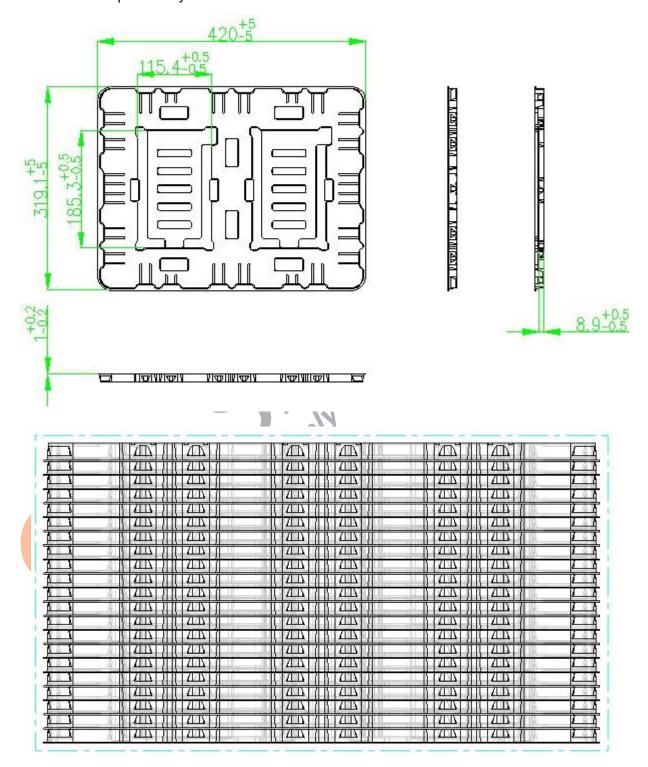
-. 单Pallet用8ea纸护角防护,捆扎带固

-. 容量: 4 EA Box/层,共3层,480pcs



### 8.2. Description of Packing Tray

LCM 2 pcs/1 Tray





# 8.3. Description of Packing Box

(1) 16 box (max.) / 1 pallet

(2) Pallet: 1200(L) X 990(W) X 130(H) mm

(3) Pallet stack: 1200(L) X 900(W) X1015(H) mm

(4) Angle boards: L 850X 60 X 5mm



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### 9. Incoming Inspection Standard

#### 9.1 Defect defination

Critical defect CR: (Ac=0 Re=1)Bring on or maybe hurt to user.

Major defect MA:

- 1. Reflect on parts invalidation or unstable;
- 2. Product function can not meet spde;
- 3. Cosmetic defect obverously.

Minor defect MI:

- 1. Do not impact product function & performance;
- 2. Cosmetic defect unclear:
- 3. Defect can be repaired easily.

#### 9.2 Incoming Inspection

Supply 81 Purchase Refer to GB2828. 1-2003, general inspection level II, Qualification level is as bel ow

MA: AQL 0.4 MI: AQL 1.0



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### 10. Checklist

	Description	Request	Value
Connection	MIPI Impedance	100±10Ω	Yes
	B2B CNT	FR4, 0.3mm	No ,ZIF CNT
	ID Pin	1 <sup>st</sup> source: GND 2 <sup>nd</sup> source: 1.8V(different cell) 2 <sup>nd</sup> source: GND(same cell+IC)	GND
IC	Protection	Shielding tape on IC	Yes
FPC	Bending Area	Not exceed M/F	No
	FPC status	Unfolded while direct bonding	Yes
	GND Area	Need GND area to connect SUS	Yes
	Test Points	Need shieling tape on it	Yes
	Bending Area	Single layer	Yes
SUS	4 Corner side	At lease 1.2mm	No
Panel	Glass Generation	G5?G6?	G8.5
	Cutting Q'ty	panel Q'ty each mother glass	234pcs
	Display mode	VA/IPS	HADS
	Mask Q'ty	Array mask	6
	Pixel Domain	1 or 2?	2
	ITO@C/F	ITO square resistance, thickness	≤1000 Ω/□ , 160A
	Scan direction	Single scan or dual scan	Z inversion
	PS Parameter	Main/Sub PS density and size	Main PS density 1/72,top size 12um ;Sub PS density 70/72, top size 12um;
	Cell gap	Center point	3.35um
	LC injection	Vacuum injection or ODF	ODF
	LC Margin	>6%	-3%~3%,6%
	Pol compensation	A+C/B+B/None compensation film	None compensation film
	UV Glue	Fill out at IC around	Yes
	Pol surf. Treatment	Direct bonding: HC+Glare Air bonding: Haze44+glare(>4inch)	AG25高精细
	Pol position	Direct bonding: pol is higher 0.05mm than M/F Air bonding: pol is lower 0.05mm than M/F	pol is higher 0.119mm than M/F
Package	Surface resistance	10^4~10^9Ω	Yes
	Friction voltage	≦100V	Yes
	Layer in one Box	<10layer	No, 21layer

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